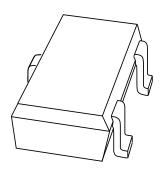
DISCRETE SEMICONDUCTORS

DATA SHEET



BAP50-05WGeneral purpose PIN diode

Product specification Supersedes data of 2001 Mar 02 2001 Apr 17



General purpose PIN diode

BAP50-05W

FEATURES

- Two elements in common cathode configuration in a small-sized plastic SMD package
- Low diode capacitance
- Low diode forward resistance.

APPLICATIONS

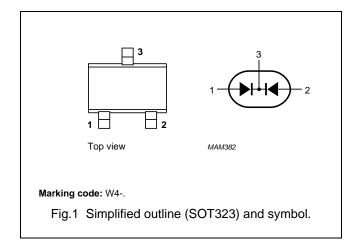
· General RF applications.

DESCRIPTION

Two planar PIN diodes in common cathode configuration in a SOT323 small SMD plastic package.

PINNING

PIN	DESCRIPTION
1	anode
2	anode
3	common cathode



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per diode					
V _R	continuous reverse voltage		_	50	V
IF	continuous forward current		_	50	mA
P _{tot}	total power dissipation	T _s = 90 °C	_	240	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

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ELECTRICAL CHARACTERISTICS

 $T_j = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per diode						
V _F	forward voltage	I _F = 50 mA	_	0.95	1.1	V
V_R	reverse voltage	I _R = 10 μA	50	_	_	V
I _R	reverse current	V _R = 50 V	_	_	100	nA
C_d	diode capacitance	V _R = 0; f = 1 MHz	_	0.45	_	pF
		V _R = 1 V; f = 1 MHz	_	0.35	0.6	pF
		V _R = 5 V; f = 1 MHz	_	0.3	0.5	pF
r _D	diode forward resistance	I _F = 0.5 mA; f = 100 MHz; note 1	_	25	40	Ω
		I _F = 1 mA; f = 100 MHz; note 1	_	14	25	Ω
		I _F = 10 mA; f = 100 MHz; note 1	_	3	5	Ω
s ₂₁ ²	isolation	V _R = 0; f = 900 MHz	_	19	_	dB
		V _R = 0; f = 1800 MHz	_	15.7	_	dB
		V _R = 0; f = 2450 MHz	_	13.5	_	dB
s ₂₁ ²	insertion loss	I _F = 0.5 mA; f = 900 MHz	_	1.84	_	dB
		I _F = 0.5 mA; f = 1800 MHz	_	1.90	_	dB
		$I_F = 0.5 \text{ mA}$; $f = 2450 \text{ MHz}$	_	1.92	_	dB
$ s_{21} ^2$	insertion loss	I _F = 1 mA; f = 900 MHz	_	1.08	_	dB
		I _F = 1 mA; f = 1800 MHz	_	1.13	_	dB
		I _F = 1 mA; f = 2450 MHz	_	1.17	_	dB
$ s_{21} ^2$	insertion loss	I _F = 10 mA; f = 900 MHz	_	0.26	_	dB
		I _F = 10 mA; f = 1800 MHz	_	0.30	_	dB
		I _F = 10 mA; f = 2450 MHz	_	0.36	_	dB
τι	charge carrier life time	when switched from I_F = 10 mA to I_R = 6 mA; R_L = 100 Ω ; measured at I_R = 3 mA	_	1.05	_	μS
L _S	series inductance	I _F = 100 mA; f = 100 MHz	_	1.6	_	nH

Note

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point		K/W

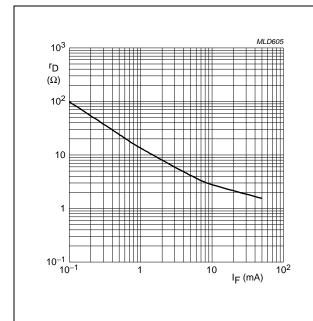
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^{1.} Guaranteed on AQL basis: inspection level S4, AQL 1.0.

General purpose PIN diode

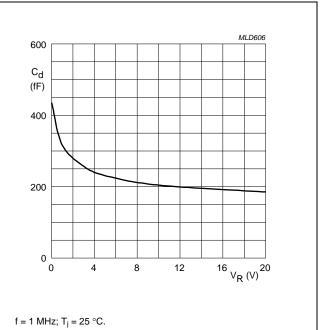
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GRAPHICAL DATA



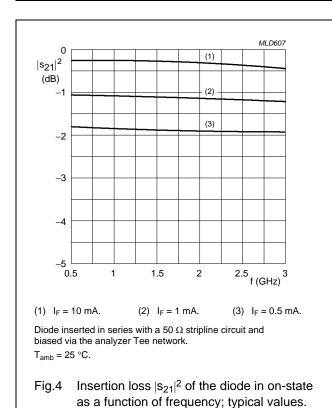
 $f = 100 \text{ MHz}; T_j = 25 \,^{\circ}\text{C}.$

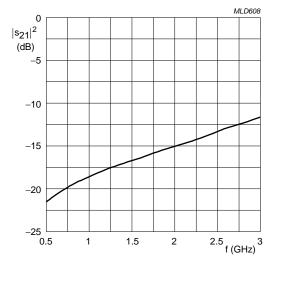
Fig.2 Forward resistance as a function of forward current; typical values.



E'n O. B'ada aanad'aana

Fig.3 Diode capacitance as a function of reverse voltage; typical values.





Diode zero biased and inserted in series with a 50 Ω stripline circuit. T_{amb} = 25 °C.

Fig.5 Isolation ($|s_{21}|^2$) of the diode in off-state as a function of frequency; typical values.

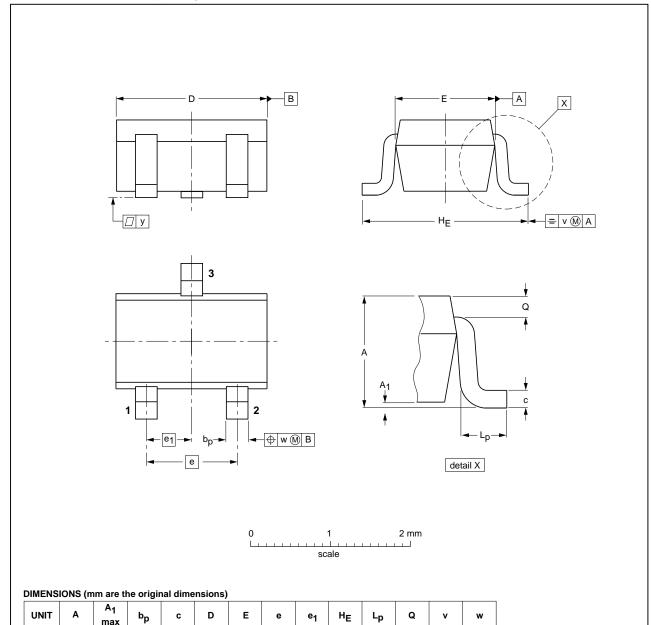
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PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT323



OUTLINE	REFERENCES		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT323			SC-70			-04-11-04 06-03-16

0.45

0.23

0.2

1.35 1.15

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max

0.1

1.1 0.8

mm

0.4 0.3

0.25

0.10

2.2

General purpose PIN diode

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

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